PCN Number:		20240502003.2					PCN Date:	May 02, 2024	
Title:	Datasheet for	ISO776x-Q1							
Custon	Change Management team Der			Dept:		Quality Services			
Proposed 1 st Ship Da		te: October 29, 2024							
Change									
Assembly Site					Design			Wafer Bum	p Material
Assembly Process			\boxtimes	Data sheet		Wafer Bump Process		p Process	
Assembly Materials				Part number change W		Wafer Fab	Wafer Fab Site		
	Mechanical Specification				Test Site			Wafer Fab	Materials
Packing/Shipping/Labeling				Test Process	5		Wafer Fab	Process	

PCN Details

Description of Change:

The product datasheet(s) is being updated as summarized below.

The following change history provides further details.

The datasheet number will be changing.

Ji3	TEXAS
A	INSTRUMENTS

ISO7760-Q1, ISO7761-Q1, ISO7762-Q1, ISO7763-Q1

SLLSEU7D - NOVEMBER 2018 - REVISED JANUARY 2024

Changes from Revision C (October 2022) to Revision D (January 2024)

- Changed V_{IORM} value for DW-16 package from "1414 V_{PK}" to "2121 V_{PK}9
- Changed V_{IOWM} values for DW-16 package from "1000 V_{RMS}" and "1414 V_{DC}" to "1500 V_{RMS}" and "2121 V_{DC}"

Device Family	Change From:	Change To:
ISO776x-Q1	SLLSEU7C	SLLSEU7D

These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/ISO7760-Q1

Reason for Change:

Supply Continuity

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

Electrical specification performance changes as indicated above.

Changes to product identification resulting from this PCN:

None.

Product Affected:

ISO7760FQDBQQ1	ISO7761FQDBQQ1	ISO7762FQDBQQ1	ISO7763FQDBQQ1
ISO7760FQDBQRQ1	ISO7761FQDBQRQ1	ISO7762FQDBQRQ1	ISO7763FQDBQRQ1
ISO7760FQDWQ1	ISO7761FQDWQ1	ISO7762FQDWQ1	ISO7763FQDWQ1
ISO7760FQDWRQ1	ISO7761FQDWRQ1	ISO7762FQDWRQ1	ISO7763FQDWRQ1
ISO7760QDBQQ1	ISO7761QDBQQ1	ISO7762QDBQQ1	ISO7763QDBQQ1
ISO7760QDBQRQ1	ISO7761QDBQRQ1	ISO7762QDBQRQ1	ISO7763QDBQRQ1
ISO7760QDWQ1	ISO7761QDWQ1	ISO7762QDWQ1	ISO7763QDWQ1

ISO7760QDWRQ1	ISO7761QDWRQ1	ISO7762QDWRQ1	ISO7763QDWRQ1

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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